

# Abstracts

## COM2 enhanced graded base SiGe technology for high speed applications (2002 [RFIC])

---

*T. Ivanov, M. Carroll, S. Moinian, M. Mastrapasqua, A. Freij, A. Chen, C. King, A. Hamad, E. Martin, S. Shive, T. Esry, C. Lee, R. Johnson, T. Sorsch, K. Banoo, P. Smith and W. Cochran. "COM2 enhanced graded base SiGe technology for high speed applications (2002 [RFIC])." 2002 Radio Frequency Integrated Circuits (RFIC) Symposium 02. (2002 [RFIC]): 337-340.*

The COM2 Enhanced Graded Base SiGe modular BiCMOS technology has been developed. It is based on the COM2 digital CMOS process. The technology achieves peak  $f_t=100$  GHz, peak  $f_{max}=101$  GHz, peak  $|s_{11}|_{beta}=186$  and  $BV_{cex}=2.05$  V.  $f_t$ - $BV_{cex}$  product of 205 and good across wafer uniformity are demonstrated.

 [Return to main document.](#)